# **Chengming Li**

8775 Costa Verde Blvd, San Diego, CA 92122 | stevenlcm16@gmail.com | 650-304-9670

Summary Portfolio: https://sites.google.com/colorado.edu/chengming-li/home | GitHub: https://github.com/stevenli518

Entrepreneurial and detail-oriented new grad at the University of Colorado, Boulder, strong at Embedded System Development and Circuit Debug, proficient in relationship building, team player and leadership mindset, confident in software and programming skills. Seeking opportunities for Electrical Engineer Internship.

#### • Fast Learner

Managed to use the internet and online references to study Python in less than 2 weeks.

## • Hardware Skills

FPGA design, Arduino, PCB design, Oscilloscope, Function/RF Generator, Digital Multimeter, Spectrum Analyzer, Network Analyzer, Surface Mount Soldering

## Programming Languages

Python, C/C++, C#, Verilog/System Verilog, Assembly (RISC-V), MATLAB, Tcl, HTML&CSS, SQL

#### Software Skills

Altium Designer (AD), LTspice, Quartus, ModelSim, Simplicity Studio, VSCode, Visual Studio, MS Office, GitHub, Confluence, Lattice, Slack

## Work/Research Experience

#### **Eridan Communications**

Sunnyvale, CA

RF Test Engineer Intern

June 2023 - Aug 2023

- Developed and executed batch scripts to semi-auto the installation process (under 5 minutes) of VScode, Python, and Rclone
- Built the MATLAB and C# to Python conversion infrastructure on GitHub for 7+ instruments and PCB test development
- Documented 4 confluence pages for Python IDEs choices, Repo Usage, Hands-off and Temperature Chamber Test results

#### University of Colorado at Boulder (Dr. Taylor Barton's RF Power and Analog Lab)

Boulder, CO

Research Assistant

Aug 2022 - May 2023

- Implemented multi-digital filters using Vivado FPGA (Red Pitaya) to reduce the distortion in the Class-AB power amplifier
- Automated the test with RF Generator, Spectrum Analyzer, and Power Supply to collect the IMD3, Pout, and Current data
- Processed the IMD3 data using Python and characterized the optimal transfer function using the network analyzer

#### **Project Experience**

## Scalable Electrosurgical Unit for Controlling and Powering the Ligasure Dissection Device

Boulder, CO

Software Lead (Sponsor: Medtronic)

Aug 2022 - May 2023

- Created ADC, PWM, SCI, and CLA modules in C on the TI TMS320F28004C board in response to firmware development
- Reduced the RMS values calculation from 25% to 1.7% errors by using the bitwise mask to optimize the instruction cycles

### 4 Layer Instrument Droid PCB Design

Boulder, CO

Individual

Nov 2022 - Dec2022

- Developed 4 Layer PCB used to measure the output impedance of any voltage source lower than 12 V in Altium Designer
- Assembled the PCB's components using the Surface Mount Technology and debugged the communication issue of I2C pins

#### Golden Arduino PCB Design

Boulder, CO

Individual

Oct 2022 - Oct 2022

- Developed the schematic and layout for the Atmega328p chip Arduino with ADC, SPI, and UART-USB features in AD
- Reduced switching and crosstalk noise by placing decoupling capacitors, continuous ground plane, and unshared return paths

#### Bluetooth communication using I2C and SPI

Boulder, CO

Team leader

Oct 2021 - Dec 2021

- Programed the SPI and I2C communication bus in C based on event-driven architecture using Thunderboard UG309
- Transmitted the on-board light sensor and 3-axis accelerometer values to the smartphone app via BLE module

**Robotic Toy Car** 

Boulder, CO

Team member Jan 2021 - May 2021

- Created a robotic toy car circuitry with motor control using H-bridge, and achieved speed and direction control using Arduino
- Designed and simulated the speed control feedback loop with amplifier and differentiator circuitry in the LTspice

# Education

University of California, San Diego

San Diego, CA

Master of Science in Electrical and Computer Engineering

May 2025

Cumulative GPA: NA/4.00

University of Colorado at Boulder

Boulder, CO

Bachelor of Science in Electrical & Computer Engineering  $\mid$  Minor in Computer Science

May 2023

Cumulative GPA: 3.81/4.00 | Honor: Dean's List (Spring 2019 – Spring 2023)

Teaching (TA) experience: Introduction to circuits and electronics

Relevant Coursework: Embedded Software Algorithm, Embedded Software Engineering, Computer Organization, Real-time Operating System, Data Structures, Algorithms, Software development, Microelectronics, Programming of Digital Systems